



Certificate US07743

The management system of

FlipChip International, LLC

3701 East University Drive,
Phoenix, AZ 85034

1914 West 3rd Street
Tempe, AZ 85281

has been assessed and certified as meeting the requirements of



ISO 14001:2004

For the following activities

Manufacture of wafer interconnects that enable semiconductor and microelectronic attachment directly to printed circuit board or chip carriers through design fabrication, wafer thinning, dicing and packaging.

Further clarifications regarding the scope of this certificate and the applicability of ISO 14001:2004 requirements may be obtained by consulting the organization.

This certificate is valid from 11 January 2007 until 3 November 2009.
Issue 1.

Authorized by

Director Accreditation North America



SGS Systems & Services Certification
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Page 1 of 1

